

# Annual Meeting 2024 JRA6 – Challenges for next generation DIS facilities (NextDIS) F. Bossù (CEA)



01

Progress achieved by the WP during the last year

02

03

Plan of

presentation

Important highlights of the performed work (last year + full project duration)

Tasks and achievements beyond the initial Work Program





## The Next Generation DIS facility → EIC

The Electron-Ion Collider (EIC) is the next generation hadron physics facility on our immediate horizon focused on a range of critical questions in QCD that remain unanswered. **Electron-Ion Collider**:

- World's first polarised electron-proton/light ion and electron-nucleus collider
- high luminosity and large CM energies for unprecedented access to the quark-gluon sea

### **EIC** milestones:

2020: CD-0, BNL is selected as host lab EIC Yellow Report
2021: CD-1, the EIC project execution starts







### The Next Generation DIS facility → EIC









### A long journey

2022: ePIC collaboration forms

CD-3, expected 2025-26, will mark the start of the construction phase Start of operations ~ mid 2030s

now





### **Detector requirements:**

- Hermetic detector
- Excellent tracking and vertex resolution
- Very good PID (  $e/\pi$ ,  $\pi/K$ , p/K ) in a wide momentum and angular range



## **Objectives of JRA:**

- 1 Monte-Carlo simulations for detector requirement definition
- 2 Very low ion-back-flow detectors for tracking with TPC
- 3 Particle identification with RICH
- 4 Depleted MAPS for vertex detector and tracking

CAVEAT: Many changes in the EIC detector choices steered our activities





## Task 1: Monte Carlo simulations

- Deliverable achieved in 2021, coinciding with the EIC Yellow Report.
- Particular focus on exclusive reactions (DVCS, DVMP, TCS)
- Use of EpIC generator (from the PARTONS framework, VA2) in ePIC
- Since summer 2023, monthly simulation campaigns in ePIC
- Workflow example: TCS









- JRA6-tasks members are involved in detector simulations for ECCE/ATHENA → ePIC
- From the 2022 detector baseline (the ECCE proposal), the ePIC detector evolved substantially
- Current focus: realistic implementation of detectors in Geant4:
  - Silicon Vertex Tracker (SVT)
  - MicroPattern Gaseous Detectors (MPGD)
  - Dual radiator RICH
- Performance studies











## Task 2: Low IBF for TPC read out

- A novel structure for ion backflow reduction was studied: a Micromegas detector was couple with a GEM+micromesh pre-amplification
- IBF values lower than 0.3% have been reached
- Results have been published in 2022. doi:10.1016/j.nima.2022.167752









# Task 2: MPGD for tracking in ePIC



- CyMBaL: a tracking layer close to the inner silicon vertex tracker
- It provides additional hit points for track finding

#### Requirements:

- ~150µm spatial resolution,
- ~10ns time resolution
- Full acceptance
- Low material budget
- **Dimensions**:
  - Inner radius 55 cm
  - Length 2.4 m
- 32 modules
- Readout based on a new ASIC: SALSA



### Technology

- Cylindrical resistive Micromegas technology developed for the CLAS12 experiment. At work since 2017 in high radiation and B=5 T
- Compact and modular
- Ongoing R&D
  - 2D readout with 1 mm pitch orthogonal strips



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### Test beam in MAMI in 2023







Compact cost-effective solution for particle identification in the high-energy endcap at EIC



Forward particle detection

Hadron ID in the extended 3-50 GeV/c interval

Support electron ID up to 15 GeV/c



#### Main challenges:

Cover wide momentum range 3 - 50 GeV/c -> dual radiator Work in high (~ 1T) magnetic field Fit in a quite limited (for a gas RICH) space -> curved detector

-> SiPM









#### Acceptance: defined by pipe and barrel ECALI minimize material budget with the use of composite materials

Interferences: material budget concentrated beheind the barrel ecal and its support ring readout electronics design in order to minimize the detector box volume

![](_page_10_Picture_6.jpeg)

### Task 3 – dRICH Photo-Detector

![](_page_11_Picture_1.jpeg)

### Photon Detector Unit (PDU):

Compact to minimize space

- 4x Hamamatsu S13361-3050HS SiPM arrays
- 4x Front-End Boards (FEB)
  - 4x ALCOR chip (ToT discrimination)
- 4 x Annealing Circuitry
- 1x Read-Out Board (RDO)
- 1x Cooling plate (< -30 C)

Active area is shaped to resemble the focal surface and best exploits the focalization

![](_page_11_Picture_11.jpeg)

![](_page_11_Figure_12.jpeg)

# **Radiation Tolerance Studies**

![](_page_11_Picture_14.jpeg)

# Task 3 – dRICH Prototype

On axis optics to minimize the active area, single or double radiator imaging Vacuum technology & recovery system for efficient gas exchange

![](_page_12_Figure_2.jpeg)

![](_page_12_Picture_3.jpeg)

Gas recovery system

![](_page_12_Picture_5.jpeg)

![](_page_12_Picture_6.jpeg)

Operative prototype commissioned. Double ring imaging achieved. Performance in line with expectations except for aerogel single-photon angular resolution (worse by a factor ~ 1.5)

![](_page_13_Picture_1.jpeg)

Task 3 – 2023 Test-beam

![](_page_13_Figure_2.jpeg)

Gas ring coverage: 60% Aerogel ring coverage: 40 %

![](_page_13_Figure_4.jpeg)

Optics at variance with respect EIC

![](_page_13_Picture_6.jpeg)

# Task 3 – 2024 Test-beam

SiPM Detector

![](_page_14_Picture_2.jpeg)

**Detector Mounting** 

![](_page_14_Picture_4.jpeg)

Tracking GEM+SciFi

![](_page_14_Picture_6.jpeg)

![](_page_14_Picture_7.jpeg)

### Task 3 – 2024 Test-beam

![](_page_15_Picture_1.jpeg)

Aerogel (n=1.020), negative beam, 10 GeV/c

![](_page_15_Figure_3.jpeg)

![](_page_15_Picture_4.jpeg)

### Successful campaign:

- Mixed hadron beam 2-11 GeV/c
- Various aerogel samples (1.020-1.026)
- Two gas radiators (C<sub>2</sub>F<sub>6</sub>, C<sub>4</sub>F<sub>10</sub>)
- Two SiPM working points (-40 C and -20 C)
- Two tracking systems (GEM & SciFi)
- Many optical fiters
- Beam line Cherenkov tagging
- Temperature monitor

![](_page_15_Picture_14.jpeg)

![](_page_15_Figure_15.jpeg)

![](_page_15_Picture_16.jpeg)

![](_page_16_Picture_0.jpeg)

### Task 4 – Silicon vertex and tracking for EIC

![](_page_16_Picture_2.jpeg)

• The ePIC SVT is a high precision silicon detector based on 65 nm CMOS pixels.

![](_page_16_Picture_4.jpeg)

SVT Total (active) area ~ 8.5 m<sup>2</sup>

ePIC SVT target specifications				
Spatial resolution	~ 5 um			
Power	< 40 mW/cm <sup>2</sup>			
Frame rate	≤ 2 μs			
Material budget (per layer)	IB: 0.05% X/X <sub>0</sub> OB: 0.25, 0.55% X/X <sub>0</sub> EE/HE: 0.25% X/X <sub>0</sub>			

![](_page_16_Picture_7.jpeg)

![](_page_17_Picture_0.jpeg)

### Task 4 – Silicon vertex and tracking for EIC

![](_page_17_Picture_2.jpeg)

- The ePIC SVT collaboration works with the ALICE ITS3 collaboration to develop a new generation MAPS sensor in a commercial 65 nm CMOS imaging technology
  - **Technology validation** and stitching proof of concept completed on prototype structures (MLR1 and ER1 submissions)
    - STRONG-2020 milestones and deliverables completed
- Development of low mass Outer Barrel and disks structures with integrated air cooling
  - Open curved structure for staves; corrugated support for disks
  - Design embeds channels for air cooling and support for service flexible printed circuit
  - Readout boards with opto-electric data interface at end of staves/disks

![](_page_17_Figure_10.jpeg)

![](_page_18_Picture_0.jpeg)

### Task 4 – Silicon vertex and tracking for EIC

![](_page_18_Picture_2.jpeg)

- Preliminary estimation of SVT radiation levels and hit occupancy to provide input for sensor design and specifications
- Low to moderate radiation levels
  - Fluence levels well below  $10^{11} n_{eq} \text{ cm}^{-2}$ . Only a few regions reaching  $10^{12} n_{eq} \text{ cm}^{-2}$
  - Dose below 10 krad for most of the SVT, only areas close to the beam pipe will experience TID between ten and a few hundred krad
- Hit rate dominated by background events. Hit occupancy at most ~ 10<sup>-7</sup> per pixel per frame

![](_page_18_Figure_8.jpeg)

10 GeV x 100 GeV DIS ep events 10 GeV electron beam gas and SR, 100 GeV hadron beam gas 20.8 x 22.8  $\mu$ m2 pixel, 2  $\mu$ s frame rate

	Hits/pixel/frame		Hits/pixel/frame		Hits/pixel/frame
LO	7.00E-08	ED0	1.96E-08	HD0	2.11E-08
L1	5.65E-08	ED1	7.07E-09	HD1	7.87E-09
L2	6.56E-09	ED2	6.81E-09	HD2	7.68E-09
L3	8.85E-10	ED3	6.40E-09	HD3	6.59E-09
L4	3.80E-10	ED4	5.76E-09	HD4	5.62E-09

![](_page_18_Picture_12.jpeg)

![](_page_19_Picture_0.jpeg)

- The Next DIS facility will be EIC with the ePIC detector
- Major contributions to EIC and ePIC within JRA6
- All deliverables have been achieved
- Some activities adapted and extended their scopes accordingly to the needs of the EIC detector

![](_page_19_Picture_5.jpeg)

![](_page_19_Picture_6.jpeg)

![](_page_19_Picture_7.jpeg)